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N-Channel PowerTrench[®] MOSFET 40 V, 248 A, 1.1 m Ω

Features

- Max $r_{DS(on)}$ = 1.1 m Ω at V_{GS} = 10 V, I_D = 32 A
- Max $r_{DS(on)}$ = 1.5 m Ω at V_{GS} = 4.5 V, I_D = 27 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

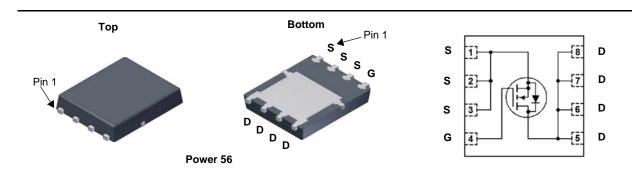


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed ang body diode reverse recovery performance.

Applications

- OringFET / Load Switching
- Synchronous Rectification
- DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	DI Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	248		
	-Continuous	T _C = 100 °C	(Note 5)	157		
D	-Continuous	T _A = 25 °C	(Note 1a)	36	Α	
	-Pulsed		(Note 4)	943		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	264	mJ	
D	Power Dissipation	T _C = 25 °C		104		
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

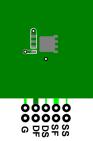
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	1.2	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient (Note 1	a) 50	C/VV	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8320L	FDMS8320L	Power 56	13 "	12 mm	3000 units

March 2016

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	40			V	
∆BV _{DSS}	Breakdown Voltage Temperature	$I_D = 250 \ \mu$ A, referenced to 25 °C		21		mV/°C	
ΔT_{J}	Coefficient	$I_D = 250 \mu$ A, referenced to 25°C		21			
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32 V, V_{GS} = 0 V$			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.7	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
j		V _{GS} = 10 V, I _D = 32 A		0.8	1.1		
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 27 \text{ A}$		1.0	1.5	mΩ	
00(01)		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 32 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		1.2	1.7	-	
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 32 \text{ A}$		206		S	
	Characteristics			1	1		
C _{iss}	Input Capacitance			8350	11110	pF	
C _{oss}	Output Capacitance	$V_{\rm DS} = 20 \text{V}, V_{\rm GS} = 0 \text{V},$		2840	3780	pF	
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		169	295	pF	
R _q	Gate Resistance		0.1	1.3	2.6	Ω	
Č.	Characteristics			1	1		
t _{d(on)}	Turn-On Delay Time			17	30	ns	
t _r	Rise Time	V _{DD} = 20 V, I _D = 32 A,		19	35	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		68	110	ns	
t _f	Fall Time			17	30	ns	
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		121	170	nC	
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 20 \text{ V},$		58	117	nC	
Q _{gs}	Gate to Source Charge	I _D = 32 A		19.2		nC	
Q _{gd}	Gate to Drain "Miller" Charge			16.5		nC	
Drain-Sou	Irce Diode Characteristics						
l _s	Diode Continuous Forward Current	T _C = 25 °C			248	А	
I _{s, pulse}	Diode Pulse Current	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$			943	А	
	Course to Desig Dia da Estatua di Valla	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.65	1.1	1	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 32 A$ (Note 2)		0.74	1.2	V	
t _{rr}	Reverse Recovery Time			68	108	ns	
Q _{rr}	Reverse Recovery Charge	- I _F = 32 A, di/dt = 100 A/μs		59	95	nC	
t _{rr}	Reverse Recovery Time	L = 22.4 di/dt = 200.4/vo		53	85	ns	
Q _{rr}	Reverse Recovery Charge	- I _F = 32 A, di/dt = 300 A/μs		104	167	nC	



2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

3. Starting T_J = 25 °C; N-ch: L = 0.3 mH, I_{AS} = 42 A, V_{DD} = 36 V, V_{GS} = 10 V.

4. Pulsed Id please refer to Fig 11 SOA graph for more details.

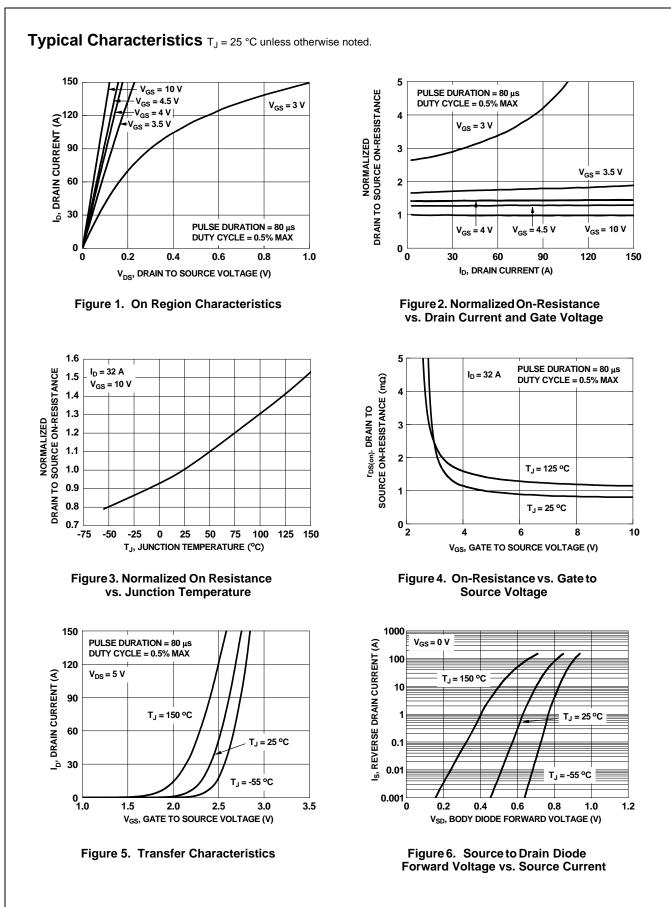
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper

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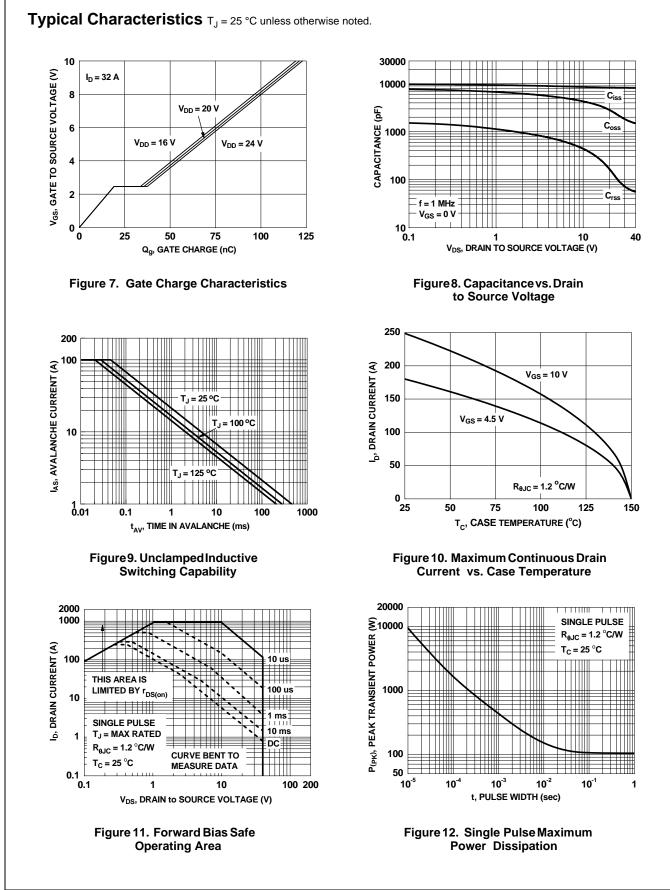
0 G PD S S b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

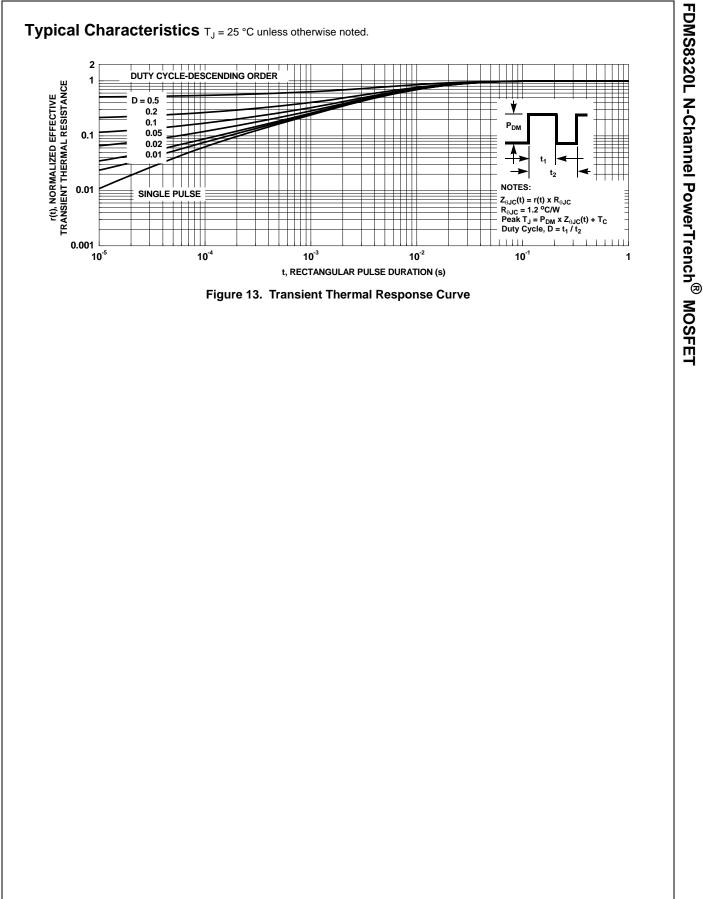
FDMS8320L N-Channel PowerTrench[®] MOSFET



FDMS8320L Rev. 1.2









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